PAN	JIT
	SEMI CONDUCTOR

Unit: inch(mm)

0.01(0.25)

0.009(0.22)

67(1.70) 59(1.50)

0.051(1.30)

.006(0.15) MAX

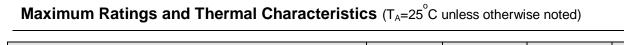
G1

0.057(1.45) MAX

PJS6600 30V Complementary Enhancement Mode MOSFET – ESD Protected SOT-23 6L Voltage 30 / -30V Current 1.6 /-1.1A **Features** .119(3.00 Advanced Trench Process Technology 0.075(1.90) • Specially Designed for Switch Load, PWM Application, etc. • ESD Protected 2KV HBM Lead free in compliance with EU RoHS 2011/65/EU 0.020(0.50) directive • Green molding compound as per IEC61249 Std. -(Halogen Free)

Mechanical Data

- Case: SOT-23 6L Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0005 ounces, 0.014 grams •
- Marking: SC0



PARAMETER	SYMBOL	N-Ch LIMIT	P-Ch LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	30	-30	V
Gate-Source Voltage		V_{GS}	<u>+</u> 8	<u>+</u> 8	V
Continuous Drain Current	I _D	1.6	-1.1	А	
Pulsed Drain Current (Note 4)		I _{DM}	6.4	-4.4	А
	T _a =25°C	5	1.25		W
Power Dissipation	Derate above 25°C	P _D	1	mW/°C	
Operating Junction and Storage Tem	T _J ,T _{STG}	-55~150		°C	
Typical Thermal resistance					
- Junction to Ambient (Note 3)		$R_{ extsf{ heta}JA}$	100		°C/W



N-Channel Electrical Characteristics (T_A=25[°]C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static	•		•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.5	0.78	1.3	V
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =1.6A	-	145	200	
	R _{DS(on)}	V _{GS} =2.5V, I _D =1.1A	-	185	270	mΩ
		V _{GS} =1.8V, I _D =0.2A	-	330	570	-
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =30V, V_{GS} =0V	-	0.01	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 8V, V _{DS} =0V	-	1.4	<u>+</u> 10	uA
Dynamic (Note 5)						
Total Gate Charge	Q_g		-	1.5	-	
Gate-Source Charge	Q_gs	V _{DS} =15V, I _D =1.6A, V _{GS} =4.5V ^(Note 1,2)	-	0.3	-	nC
Gate-Drain Charge	Q_gd	V _{GS} =4.5V	-	0.3	-	
Input Capacitance	Ciss	V _{DS} =15V, V _{GS} =0V,	-	93	-	
Output Capacitance	Coss		-	19	-	pF
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	6	-	
Turn-On Delay Time	td _(on)		-	6.4	-	
Turn-On Rise Time	tr	V_{DD} =15V, I _D =1.6A, V_{GS} =4.5V, R_{G} =6 Ω ^(Note 1.2)	-	33	-	
Turn-Off Delay Time	td _(off)		-	37	-	ns
Turn-Off Fall Time	tf	KG=017	-	32	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I _S		-	-	1.0	А
Diode Forward Voltage	V _{SD}	I _S = 1.0A, V _{GS} =0V	-	0.81	1.2	V

NOTES :

- 1. Pulse width</br>
- 2. Essentially independent of operating temperature typical characteristics.
- 3. ReJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing



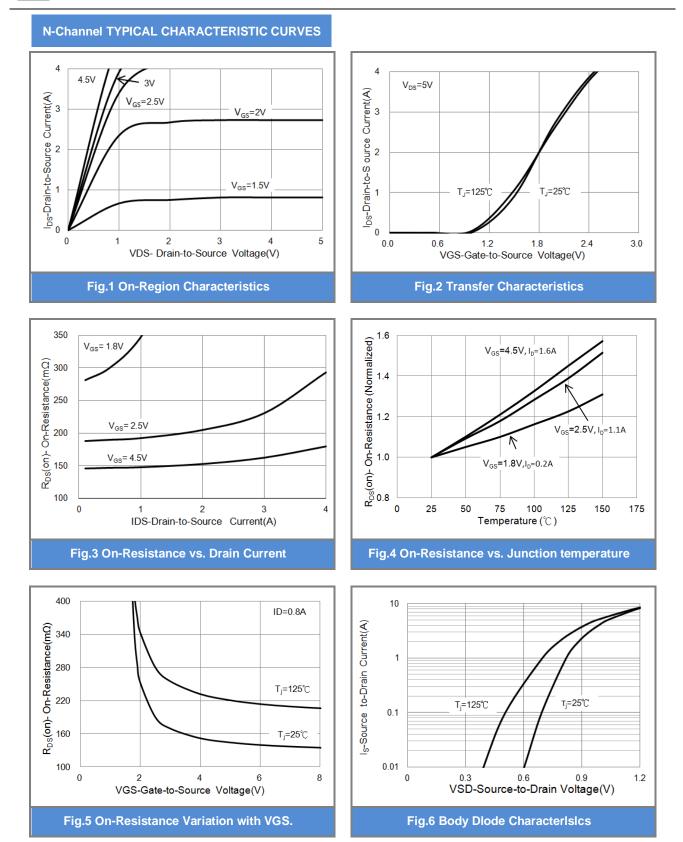
P-Channel Electrical Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static		Γ	1	1		1
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V, I_{D} =-250uA	-30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250$ uA	-0.5	-0.98	-1.3	V
Drain-Source On-State Resistance		V _{GS} =-4.5V, I _D =-1.1A	-	293	370	
	R _{DS(on)}	V _{GS} =-2.5V, I _D =-0.5A	-	387	540	mΩ
		V _{GS} =-1.8V, I _D =-0.1A	-	750	970	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =-30V, V_{GS} =0V	-	-0.01	-1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 8V, V _{DS} =0V	-	<u>+</u> 3.4	<u>+</u> 10	uA
Dynamic (Note 5)						
Total Gate Charge	Qg		-	1.6	-	
Gate-Source Charge	Q _{gs}	V_{DS} =-15V, I_{D} =-1.1A,	-	0.5	-	nC
Gate-Drain Charge	Q_gd	V _{GS} =-4.5V ^(Note 1,2)	-	0.3	-	
Input Capacitance	Ciss		-	125	-	
Output Capacitance	Coss	V_{DS} =-15V, V_{GS} =0V,	-	22	-	pF
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	6	-	
Turn-On Delay Time	td _(on)		-	11	-	
Turn-On Rise Time	tr	V_{DD} =-15V, I _D =-1.1A, V_{GS} =-4.5V, R_{G} =6 Ω ^(Note 1,2)	-	51	-	
Turn-Off Delay Time	td _(off)		-	65	-	ns
Turn-Off Fall Time	tf	K _G =012	-	46	-	
Drain-Source Diode						
Maximum Continuous Drain-Source		I _S			-1.0	А
Diode Forward Current	IS		-	-		
Diode Forward Voltage	V_{SD}	I _S =-1.0A, V _{GS} =0V	-	-0.9	-1.2	V

NOTES :

- 1. Pulse width</br>
- 2. Essentially independent of operating temperature typical characteristics.
- 3. RoJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.

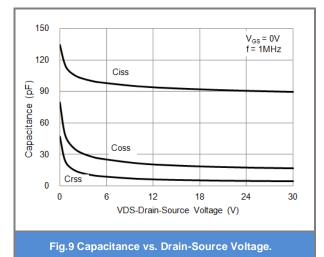


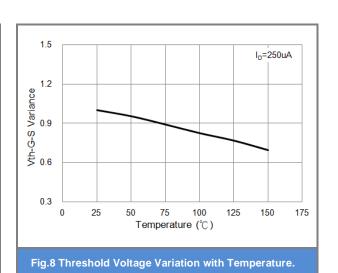


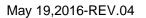


N-Channel TYPICAL CHARACTERISTIC CURVES

Fig.7 Gate-Charge Characteristics









P-Channel TYPICAL CHARACTERISTIC CURVES 4 4 V_{DS}=-5V -4 5V . 3V -I_{DS}-Drain-to-S ource Current(A) -I_{DS}-Drain-to-Source Current(A) V_{GS}=-2.5V V_{GS}=-2V T**J=125℃** T_=25℃ V_{GS}=-1.5V 2 3 4 -VDS- Drain-to-Source Voltage(V) 0 1 5 0.0 0.6 1.2 1.8 2.4 3.0 -VGS-Gate-to-Source Voltage(V) **Fig.1 On-Region Characteristics Fig.2 Transfer Characteristics** 1000 1.6 R_{DS}(on)- On-Resistance (Normalized) V_{GS}= -1.8V R_{DS}(on)- On-Resistance(mΩ) 800 1.4 V_{GS}=-4.5V, I_D=-1.1A V_{GS}=-2.5V, I_D=-0.5A 600 1.2 V_{GS}=-1.8V, I_D=-0.1A V_{GS}= -2.5V 400 1.0 V_{GS}= -4.5V 200 0.8 75 100 Temperature (℃) 0 2 2 0 25 **50** 125 150 175 1 1 -IDS-Drain-to-Source Current(A) Fig.3 On-Resistance vs. Drain Current Fig.4 On-Resistance vs. Junction temperature 10 900 ID=-0.55A -Is-Source to-Drain Current(A) R_{DS}(on)- On-Resistance(mΩ) 00 002 002 1 . Ti=125℃ T_j=125℃ Tj=25℃ 0.1 Tj=25℃ 0.01 100 0 2 4 -VGS-Gate-to-Source Voltage(V) 0 0.3 0.6 0.9 1.2 8 6 -VSD-Source-to-Drain voltage(V) Fig.5 On-Resistance Variation with VGS. **Fig.6 Body Dlode CharacterIsIcs**



P-Channel TYPICAL CHARACTERISTIC CURVES

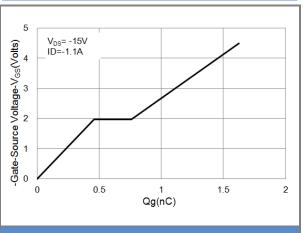
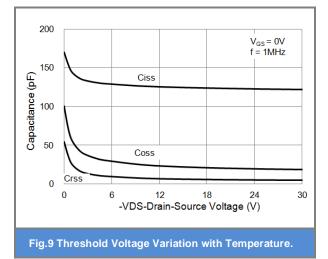
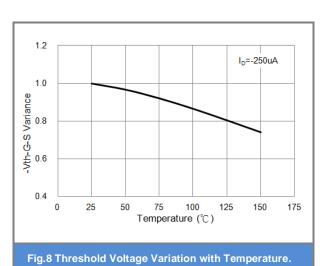


Fig.7 Gate-Charge Characteristics







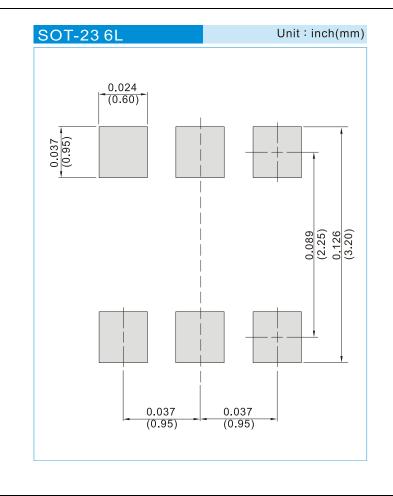




PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJS6600_S1_00001	SOT-23 6L	3K pcs / 7" reel	SC0	Halogen free
PJS6600_S2_00001	SOT-23 6L	10K pcs / 13" reel	SC0	Halogen free

MOUNTING PAD LAYOUT







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